Single-Molecular Protein-based Bioelectronics via Electronic Transport: Fundamental, Devices and Applications

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Schematics of protein junctions fabricated by different methods

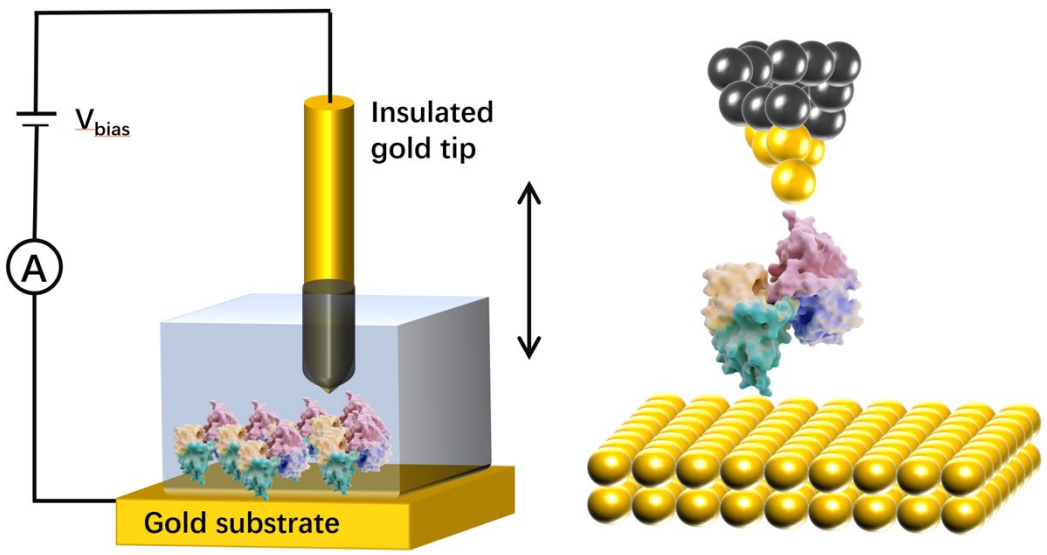

Figure S1 Scanning tunnelling microscopy break junction.

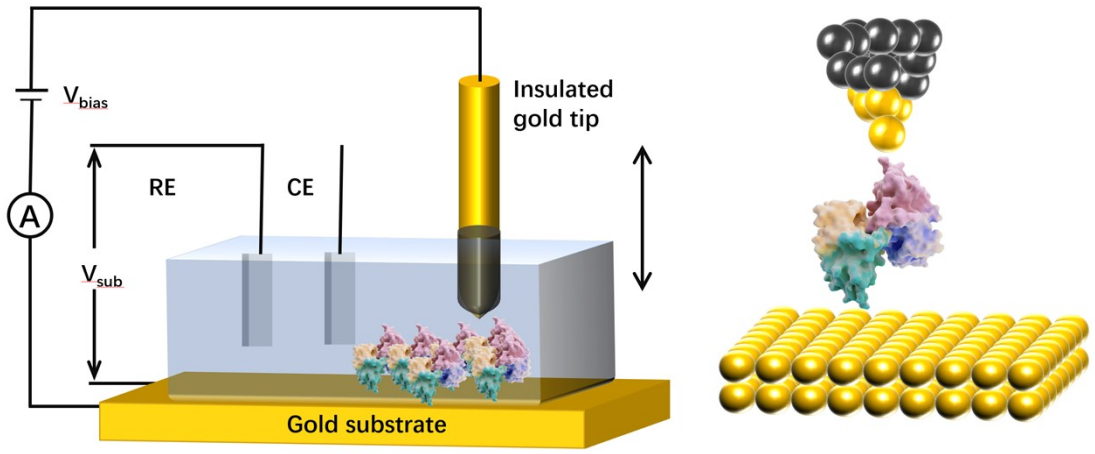

Figure S2 Electrochemical scanning tunnelling microscopy.

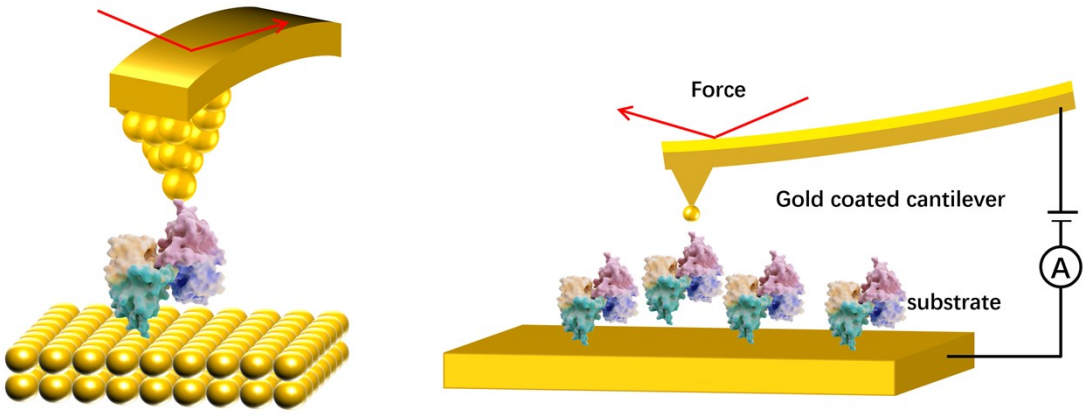

Figure S3 Conducting probe atomic force microscopy break junction.

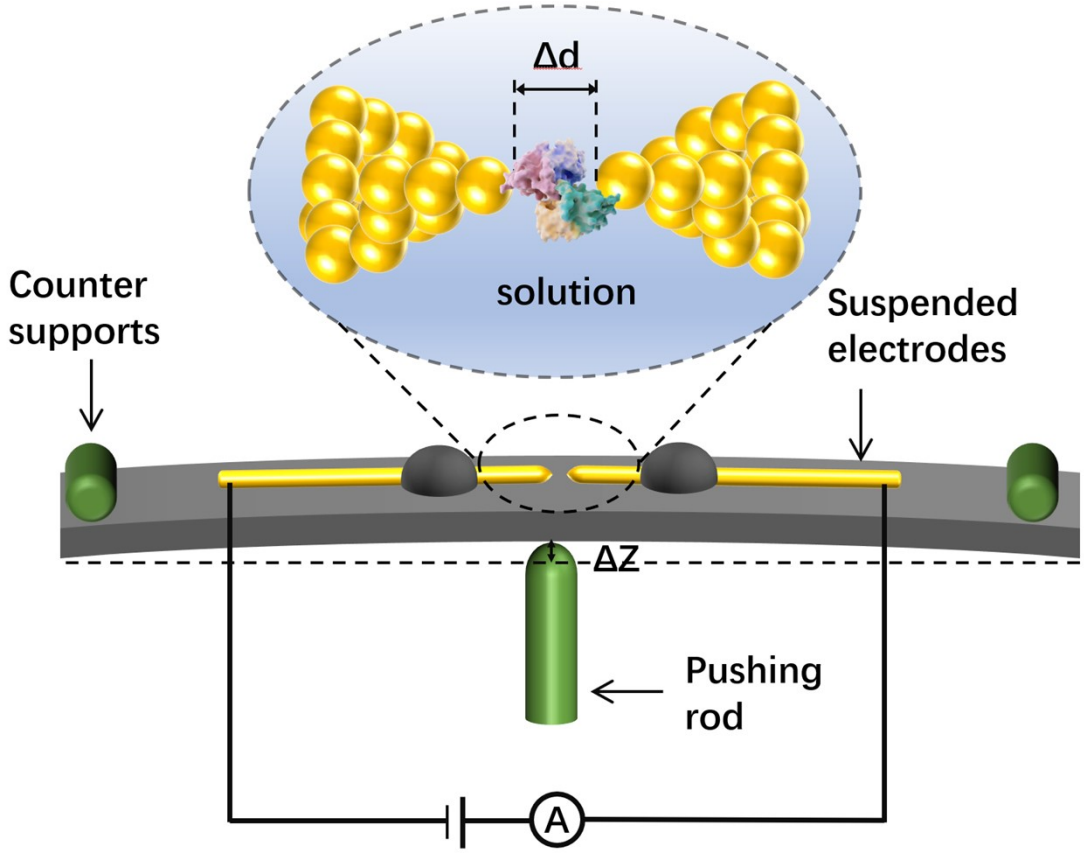

Figure S4 Mechanically controlled break junctions.

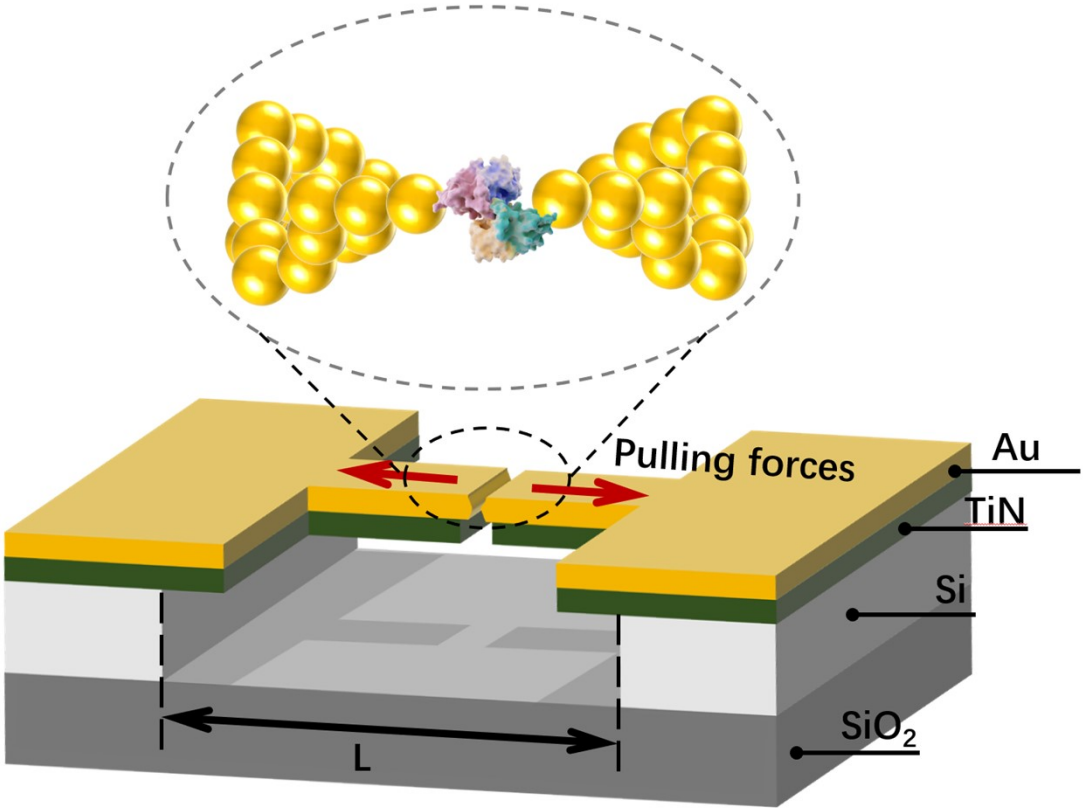

Figure S5 Crack-defined break junction.

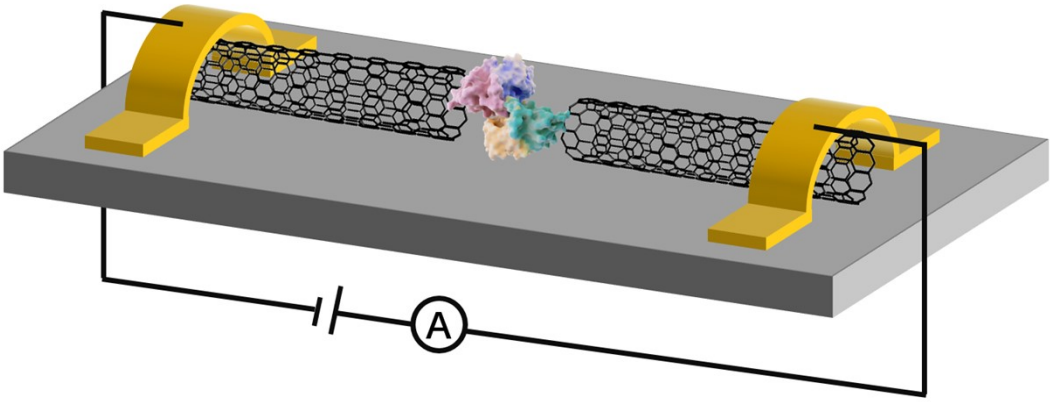

Figure S6 Lithography-defined cutting protein junction based on single-walled carbon nanotubes.

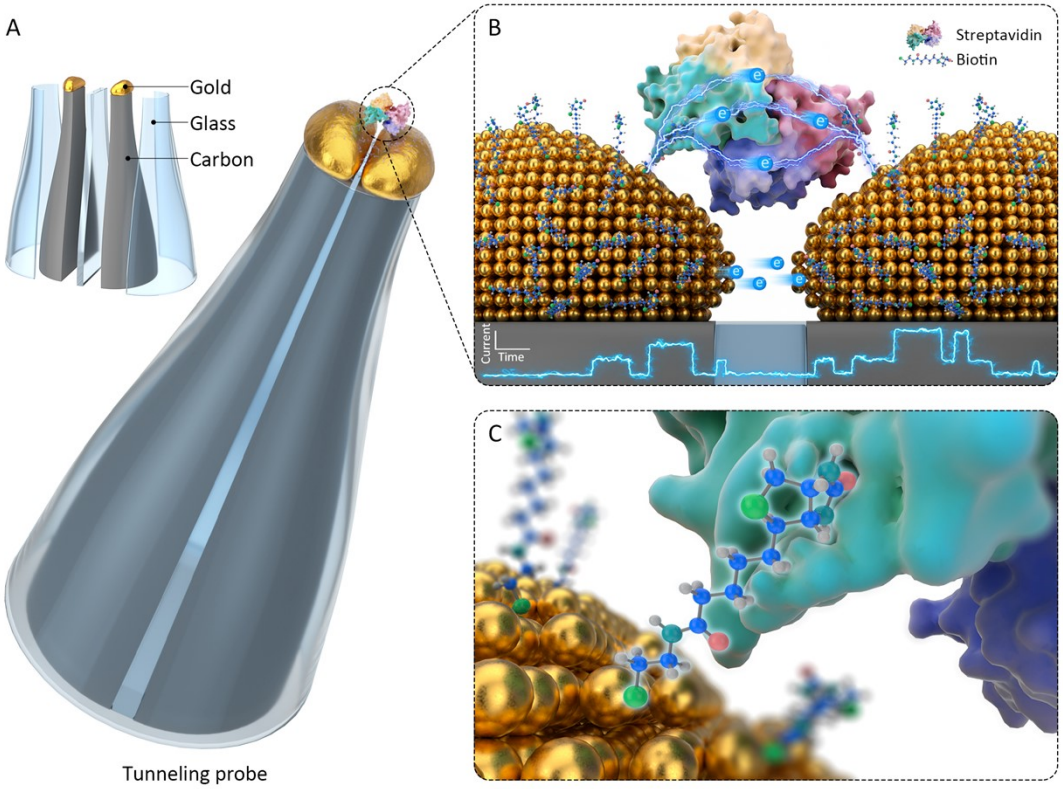

Figure S7 Protein junction based on electrochemical deposition.

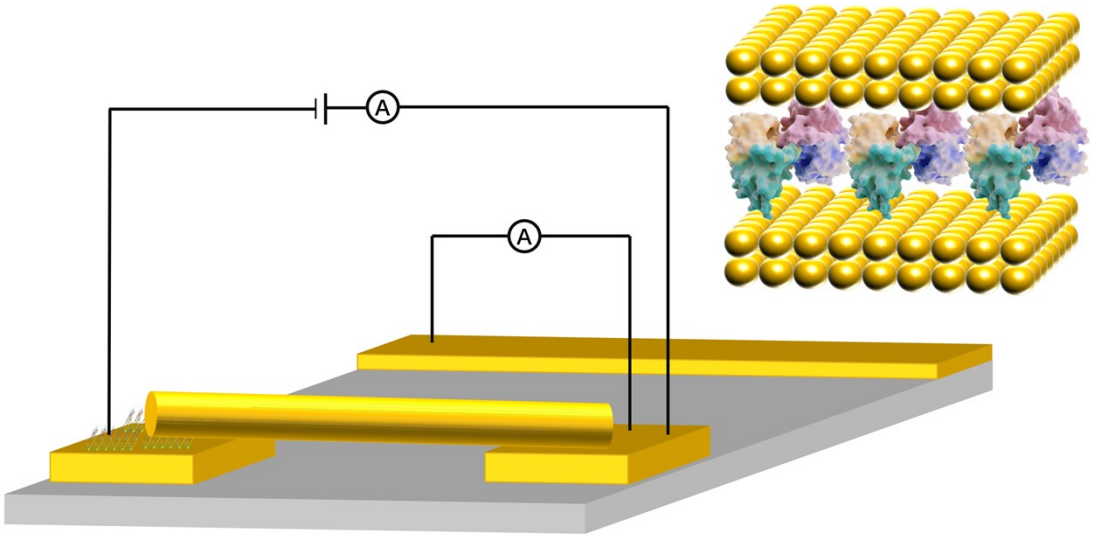

Figure S8 Nanowire cross-protein junction.

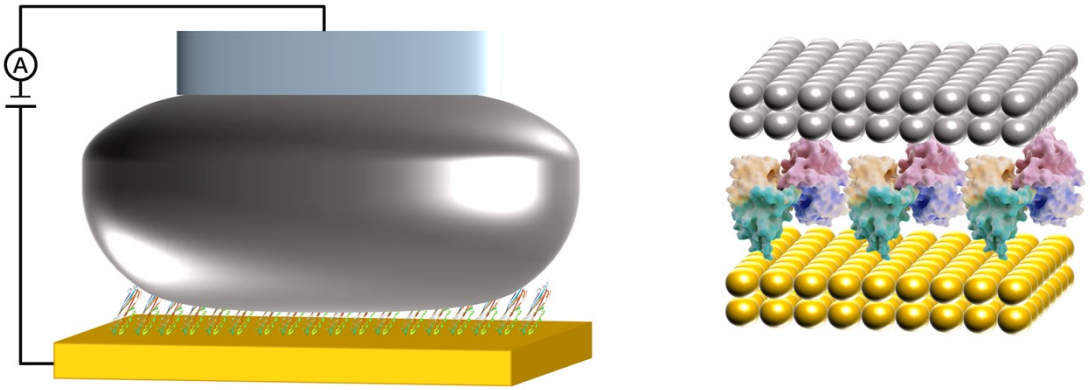

Figure S9 Liquid metal contact junctions.

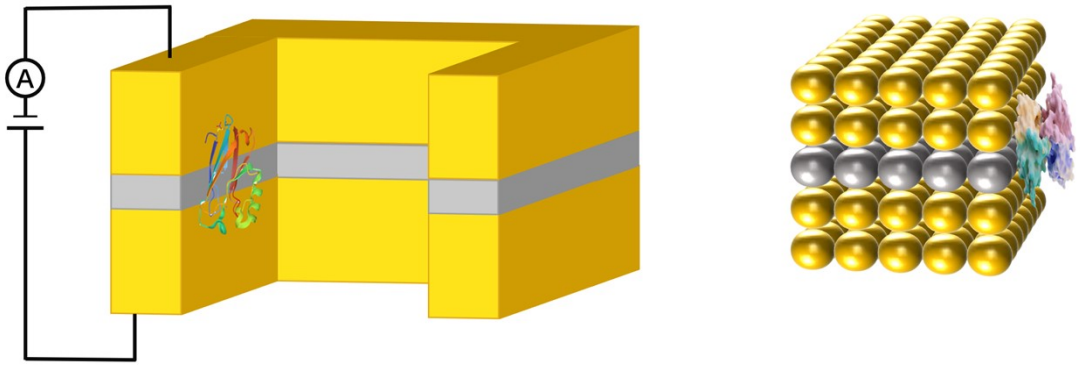

Figure S10 Stacking junction.